505080497 09/06/2018

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT5127254

SUBMISSION TYPE:	CORRECTIVE ASSIGNMENT
	Corrective Assignment to correct the ASSIGNEE CITY TO SAN DIEGO previously recorded on Reel 037467 Frame 0159. Assignor(s) hereby confirms the ASSIGNEE CITY IS SAN DIEGO.

CONVEYING PARTY DATA

Name	Execution Date
LIN YANG	09/02/2015
DUNG NGOC DOAN	01/07/2016
BIN TIAN	09/03/2015
SAMEER VERMANI	01/07/2016

RECEIVING PARTY DATA

Name:	QUALCOMM INCORPORATED
Street Address:	5775 MOREHOUSE DRIVE
City:	SAN DIEGO
State/Country:	CALIFORNIA
Postal Code:	92121-1714

PROPERTY NUMBERS Total: 5

Property Type	Number
Application Number:	14843538
Application Number:	62046086
Application Number:	62054932
Application Number:	62064935
Application Number:	62067260

CORRESPONDENCE DATA

Fax Number: (202)857-6395

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 202-857-6000

Email: patentdocket@arentfox.com, rebecca.golden@arentfox.com

Correspondent Name: ARENT FOX LLP **Address Line 1:** 1717 K STREET, NW

Address Line 4: WASHINGTON, D.C. 20006-5344

ATTORNEY DOCKET NUMBER: 030284.10491/147016

NAME OF SUBMITTER: REBECCA GOLDEN

PATENT 505080497 REEL: 047028 FRAME: 0490

SIGNATURE:	/REBECCA GOLDEN/
DATE SIGNED:	09/06/2018
Total Attachments: 16	
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Confirmation Receipt

Your assignment has been received by the USPTO. The coversheet of the assignment is displayed below:

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2

 SUBMISSION TYPE:
 NEW ASSIGNMENT

 NATURE OF CONVEYANCE:
 ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
LIN YANG	09/02/2015
DUNG NGOC DOAN	01/07/2016
BIN TIAN	09/03/2015
SAMEER VERMANI	01/07/2016

RECEIVING PARTY DATA

Name:	QUALCOMM INCORPORATED
Street Address:	5775 MOREHOUSE DRIVE
City:	LOS ANGELES
State/Country:	CALIFORNIA
Postal Code:	92121-1714

PROPERTY NUMBERS Total: 5

Property Type	Number
Application Number:	14843538
Application Number:	62046086

PATENT

REEL: 047028 FRAME: 04922016 12:51 PM

Application Number:	62054932
Application Number:	62064935
Application Number:	62067260

CORRESPONDENCE DATA

Fax Number: (202)857-6395 **Phone:** 213-629-7400

Email: dcipdocket@arentfox.com

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if

provided; if that is unsuccessful, it will be sent via US Mail.

Correspondent Name: ARENT FOX, LLP AND QUALCOMM, INCORPORATE

Address Line 1: 1717 K STREET, NW

Address Line 4: WASHINGTON, D.C. 20006-5344

000000000000000000000000000000000000000	ATTORNEY DOCKET NUMBER:	030284.10491/147016
000000000000000000000000000000000000000	NAME OF SUBMITTER:	RACHELE WITTWER
000000000000000000000000000000000000000	Signature:	/Rachele Wittwer/
000000000000000000000000000000000000000	Date:	01/12/2016

Total Attachments: 6

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RECEIPT INFORMATION

EPAS ID: PAT3692061 **Receipt Date:** 01/12/2016

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PATENT QUALCOMM Ref. No. 147016 Page 1 of 3

ASSIGNMENT

WHEREAS, WE,

- 1. Lin YANG, a citizen of the United States of America, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121-1714, and a resident of San Diego, California,
- Dung Ngoc DOAN, a citizen of the United States of America, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121-1714, and a resident of San Diego, California,
- 3. **Bin TIAN**, a citizen of the United States of America, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121-1714, and a resident of San Diego, California,
- 4. Sameer VERMANI, a citizen of India, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121-1714, and a resident of San Diego, California,

have conceived of one or more processes, methods, machines, articles of manufacture, designs, compositions of matter, inventions, discoveries or new or useful improvements relating to TONE PLAN FOR LTF COMPRESSION (collectively the "INVENTIONS") for which WE have executed and/or may execute one or more patent applications therefor; and

WHEREAS, QUALCOMM Incorporated (hereinafter "ASSIGNEE"), a Delaware corporation, having a place of business at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A., desires to acquire or otherwise obtain the entire right, title, and interest in and to said INVENTIONS, including all inventions related thereto or thereof, all patent applications therefor, and all patents that have granted or may be granted hereafter thereon, including but not limited to those identified below.

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, WE do hereby acknowledge that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, the entire right, title, and interest throughout the world in and to said INVENTIONS, including all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in the United States, including but not limited to U.S. Application No(s). 14843538 filed September 2, 2015. Qualcomm Reference No. 147016, and all provisional applications relating thereto, together with U.S. Provisional Application No(s). 62/046,086, filed September 4, 2014, Qualcomm Reference No. 147016P1, U.S. Provisional Application No(s). 62/054,932, filed September 24, 2014. Qualcomm Reference No. 147016P2, U.S. Provisional Application No(s), 62/064,935, filed October 16, 2014, Qualcomm Reference No. 147016P3, and U.S. Provisional Application No(s). 62/067,260, filed October 22, 2014, Qualcomm Reference No. 147016P4, (and do hereby authorize ASSIGNEE and its representative to hereafter add herein such application number(s) and/or filing date(s) when known), and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, and design applications thereof, and

all issued patents of the United States which may have granted or may be granted hereafter thereon and all reissues, renewals, reexaminations, and extensions to any of the foregoing and all patents issuing thereon in the United States;

AND WE further do acknowledge and agree that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, all rights of priority under International Conventions, Treaties, or Agreements, and the entire right, title, and interest throughout the world in said INVENTIONS, including all inventions related thereto or thereof, and all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in any foreign country, countries, or treaty/union organizations, and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, patent of addition applications, confirmation applications, validation applications, utility model applications, and design applications thereof, and all issued patents which may have granted or may be granted hereafter for said INVENTIONS in any country or countries foreign to the United States, and all reissues, renewals, reexaminations, and extensions thereof;

AND WE DO HEREBY authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications or registrations, to issue all patents for said INVENTIONS to said ASSIGNEE, its successors, its legal representatives and its assigns, in accordance with the terms of this instrument;

AND WE DO HEREBY sell, assign, transfer, and convey to said ASSIGNEE, its successors, its legal representatives, and its assigns all claims for damages and all remedies arising out of or relating to any violation(s) of any of the rights assigned hereby that have or may have accrued prior to the date of assignment to said ASSIGNEE, or may accrue hereafter, including, but not limited to the right to sue for, seek, obtain, collect, recover, and retain damages and any ongoing or prospective royalties to which WE may be entitled, or that WE may collect for any infringement or from any settlement or agreement related to any of said patents before or after issuance;

AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries;

PATENT QUALCOMM Ref. No. 147016 Page 3-of 3

AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

Done at	, on		
	LOCATION	DATE	Dung Ngoc DOAN
	5a. 0,90		
Done at	⇒ , on	1151.3	Constant of the constant of th
	LOCATION	DATE	Bin TIAN

ASSIGNMENT

WHEREAS, WE,

- 1. Lin YANG, a citizen of the United States of America, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121-1714, and a resident of San Diego, California,
- 2. **Dung Ngoe DOAN**, a citizen of the United States of America, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121-1714, and a resident of San Diego, California.
- 3. **Bin TIAN**, a citizen of the United States of America, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121-1714, and a resident of San Diego, California,
- 4. **Sameer VERMANI**, a citizen of India, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121-1714, and a resident of San Diego, California,

have conceived of one or more processes, methods, machines, articles of manufacture, designs, compositions of matter, inventions, discoveries or new or useful improvements relating to TONE PLAN FOR LTF COMPRESSION (collectively the "INVENTIONS") for which WE have executed and/or may execute one or more patent applications therefor; and

WHEREAS, QUALCOMM Incorporated (hereinafter "ASSIGNEE"), a Delaware corporation, having a place of business at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A., desires to acquire or otherwise obtain the entire right, title, and interest in and to said INVENTIONS, including all inventions related thereto or thereof, all patent applications therefor, and all patents that have granted or may be granted hereafter thereon, including but not limited to those identified below.

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged. WE do hereby acknowledge that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, the entire right, title, and interest throughout the world in and to said INVENTIONS, including all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in the United States. including but not limited to U.S. Application No(s). 14843538 filed September 2, 2015. Qualcomm Reference No. 147016, and all provisional applications relating thereto, together with U.S. Provisional Application No(s), 62/046,086, filed September 4, 2014, Qualcomm Reference No. 147016P1. U.S. Provisional Application No(s), 62/054,932, filed September 24, 2014. Qualcomm Reference No. 147016P2, U.S. Provisional Application No(s), 62/064,935, filed October 16, 2014, Qualcomm Reference No. 147016P3, and U.S. Provisional Application No(s). 62/067,260, filed October 22, 2014. Qualcomm Reference No. 147016P4, (and do hereby authorize ASSIGNEE and its representative to hereafter add herein such application number(s) and/or filing date(s) when known), and all divisional applications, renewal applications. continuation applications, continuation-in-part applications, and design applications thereof, and

all issued patents of the United States which may have granted or may be granted hereafter thereon and all reissues, renewals, reexaminations, and extensions to any of the foregoing and all patents issuing thereon in the United States:

AND WE further do acknowledge and agree that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, all rights of priority under International Conventions, Treaties, or Agreements, and the entire right, title, and interest throughout the world in said INVENTIONS, including all inventions related thereto or thereof, and all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in any foreign country, countries, or treaty/union organizations, and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, patent of addition applications, confirmation applications, validation applications, utility model applications, and design applications thereof, and all issued patents which may have granted or may be granted hereafter for said INVENTIONS in any country or countries foreign to the United States, and all reissues, renewals, reexaminations, and extensions thereof;

AND WE DO HEREBY authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications or registrations, to issue all patents for said INVENTIONS to said ASSIGNEE, its successors, its legal representatives and its assigns, in accordance with the terms of this instrument:

AND WE DO HEREBY sell, assign, transfer, and convey to said ASSIGNEE, its successors, its legal representatives, and its assigns all claims for damages and all remedies arising out of or relating to any violation(s) of any of the rights assigned hereby that have or may have accrued prior to the date of assignment to said ASSIGNEE, or may accrue hereafter, including, but not limited to the right to sue for, seek, obtain, collect, recover, and retain damages and any ongoing or prospective royalties to which WE may be entitled, or that WE may collect for any infringement or from any settlement or agreement related to any of said patents before or after issuance;

AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries;

Lin YANG Done at ______, on _____ LOCATION DATE Bin TIAN Done at Sea Direction of 1671 2015
LOCATION DATE

AND WE HEREBY covenant that WE will not execute any writing or do any act

whatsoever conflicting with these presents.

PATENT REEL: 047028 FRAME: 0499

Sameer VERMANI

ASSIGNMENT

WHEREAS, WE,

- Lin YANG, a citizen of the United States of America, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121-1714, and a resident of San Diego, California,
- Dung Ngoc DOAN, a citizen of the United States of America, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121-1714, and a resident of San Diego, California.
- 3. **Bin TIAN,** a citizen of the United States of America, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121-1714, and a resident of San Diego, California,
- 4. **Sameer VERMANI,** a citizen of India, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121-1714, and a resident of San Diego, California,

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AND WE DO HEREBY authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications or registrations, to issue all patents for said INVENTIONS to said ASSIGNEE, its successors, its legal representatives and its assigns, in accordance with the terms of this instrument;

AND WE DO HEREBY sell, assign, transfer, and convey to said ASSIGNEE, its successors, its legal representatives, and its assigns all claims for damages and all remedies arising out of or relating to any violation(s) of any of the rights assigned hereby that have or may have accrued prior to the date of assignment to said ASSIGNEE, or may accrue hereafter, including, but not limited to the right to sue for, seek, obtain, collect, recover, and retain damages and any ongoing or prospective royalties to which WE may be entitled, or that WE may collect for any infringement or from any settlement or agreement related to any of said patents before or after issuance:

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PATENT

QUALCOMM Ref. No. 147016

Page 3 of 3

AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

Done at	, on LOCATION	DATE	Lin YANG	
Done at	, on			
	LOCATION	DATE	Dung Ngoc DOAN	
Done at	Ja. 0,90	913/15	and the second second	
ione at	LOCATION on	DATE	Bin TIAN	
Done at	LOCATION , on	DATE	Sameer VERMANI	

ASSIGNMENT

WHEREAS, WE,

- 1. **Lin YANG**, a citizen of the United States of America, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121-1714, and a resident of San Diego, California.
- Dung Ngoc DOAN, a citizen of the United States of America, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121-1714, and a resident of San Diego, California.
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AND WE DO HEREBY sell, assign, transfer, and convey to said ASSIGNEE, its successors, its legal representatives, and its assigns all claims for damages and all remedies arising out of or relating to any violation(s) of any of the rights assigned hereby that have or may have accrued prior to the date of assignment to said ASSIGNEE, or may accrue hereafter, including, but not limited to the right to sue for, seek, obtain, collect, recover, and retain damages and any ongoing or prospective royalties to which WE may be entitled, or that WE may collect for any infringement or from any settlement or agreement related to any of said patents before or after issuance;

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AND WE HEREBY covenant that WE will not execute any writing or do any act

whatsoever conflicting with these presents.

Done at Son Diego, on Olio 12015 LOCATION DATE

Sameer VERMANI

PATENT REEL: 047028 FRAME: 0505

RECORDED: 09/06/2018